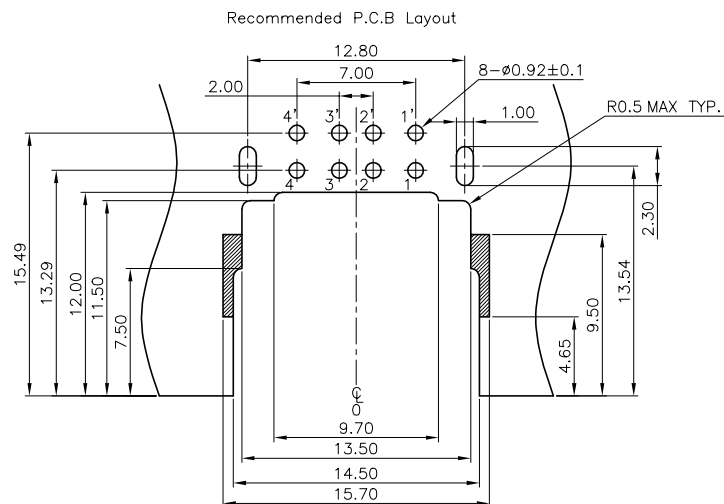
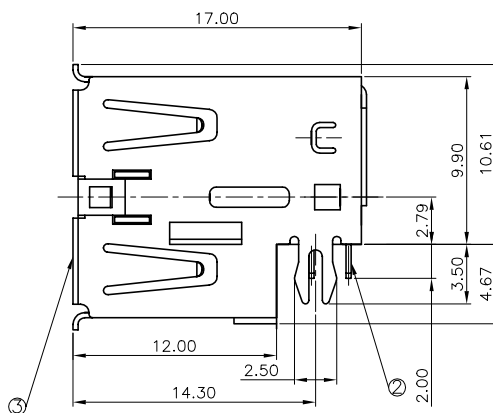
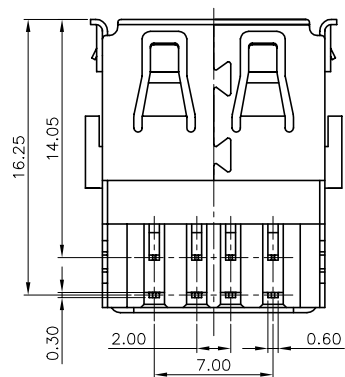
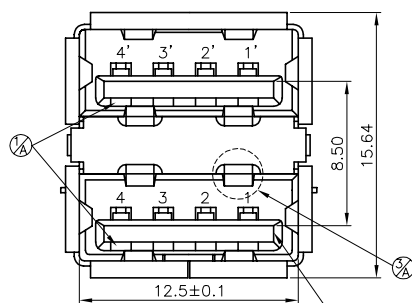
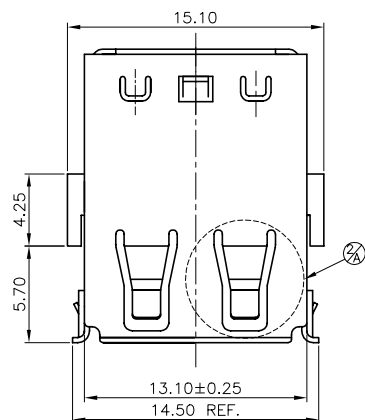




1 NOTE:
020122MR008 23ZU

1. Selective plating
'S1,-05u" Min. gold in contact area/
100u" Min. Tin in solder area.
'S2,-Gold flash in contact area/
100u" Min. Tin in solder area.
'S3,-10u" Min. gold in contact area/
100u" Min. Tin in solder area.
'S4,-15u" Min. gold in contact area/
100u" Min. Tin in solder area.
'S5,-30u" Min. gold in contact area/
100u" Min. Tin in solder area.
'S6,-50u" Min. gold in contact area/
100u" Min. Tin in solder area.

5				
4				
3	Shell	C2680H	—	NICK PLATED
2	Terminal	Pho.Bronze	—	Gold/Tin
1	Housing	LCP	BLACK	UL94V-0
NO.	DESCRIPTION	MATERIAL	COLOR	REMARK

SUYIN

CONNECTOR

CUSTOMER COPY		TITLE: USB Series A Type Dual Port Dip Type						
PART NO.			020122MR008SX23ZU					
PART NO. (OLD)			2522A-08GXT-W					
DRAWING NO.		D ING	020122MR008SX23ZU					
SCALE	4:1	UNIT	mm	A4				

						Angle	±2°	DRAW	李儒平	02/07/08
						30 ~	±0.50			
	A		A1:增加塑膠料;A2,A3:修改鐵殼彈片			10 ~ 30	±0.30	DESIGN	李儒平	02/07/08
	O	02/07/11	NEW			~ 10	±0.15	CHECK	宋權哲	02/07/08
ECN NO.	REV	DATE	DESCRIPTION	CHANGE	APPRO.	GENERAL TOLERANCE UNLESS OTHERWISE NOTED		APPRO.	宋權哲	02/07/08